

40V Dual N-Channel Enhancement Mode MOSFET

Voltage

40 V

Current

57 A

Features

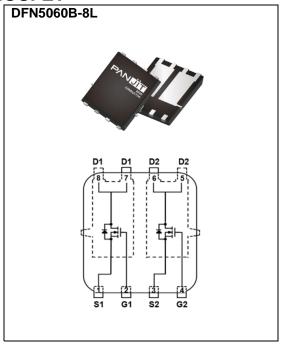
- RDS(ON), VGS@10V, ID@10A<7m Ω
- RDS(ON), VGS@7V, ID@6A<8.4m Ω
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060B-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.092 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	±20	\ \	
Continuous Drain Current(Note 3)	T _C =25°C	I _D	57		
	T _C =100°C		41	Α	
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	228		
Power Dissipation	T _C =25°C	Po	42	W	
	T _C =100°C		21		
Continuous Drain Current(Note 4)	T _A =25°C	Ι _D	14		
	T _A =70°C		12	A	
Power Dissipation	T _A =25°C	Po	2.5	W	
	T _A =70°C	PD	1.8		
Single Pulse Avalanche Energy ^(Note 5)		Eas	43	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	3.6	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	40	,,	.,	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =50uA	2	2.8	3.5	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =10A	-	5.6	7	mΩ
		V _{GS} =7V, I _D =6A	-	6.5	8.4	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Dynamic ^(Note 6)	•					•
Total Gate Charge	Q_g	V _{DS} =32V, I _D =10A, V _{GS} =10V	ı	23	31	nC
Gate-Source Charge	Qgs		-	5	-	
Gate-Drain Charge	Q_{gd}		-	6	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1MHz	-	1283	1668	pF
Output Capacitance	Coss		-	252	378	
Reverse Transfer Capacitance	Crss		-	46	80	
Gate resistance	Rg	f=1MHz	-	0.8	-	Ω
Turn-On Delay Time	td _(on)	V _{DS} =32V, I _D =10A, V _{GS} =10V, R _G =3Ω	-	14	-	
Turn-On Rise Time	tr		-	3	-	
Turn-Off Delay Time	td _(off)		-	24	-	ns
Turn-Off Fall Time	tf	(Note 2)	-	5	-	
Drain-Source Diode	-				•	
Diode Forward Current	Is	T 05°0	-	-	57	
Pulsed Diode Forward Current	I _{SM}	T _C =25°C	-	-	228	Α
Diode Forward Voltage	V _{SD}	Is=20A, V _{GS} =0V	-	0.86	1.3	V
Reverse Recovery Time	Trr	V _{DD} =20V,V _{GS} =0V	-	24	-	ns
Reverse Recovery Charge	Qrr	I _S =20A,dI _S /dt=100A/us	-	11	-	nC

NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an $R_{\theta JC}=3.6^{\circ}C/W$.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH, I_{AS}=13A, V_{DD}=30V, V_{GS}=10V, Starting T_J=25°C. the chip is about to carry I_{AS}≈26A.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

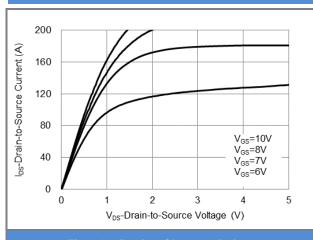


Fig.1 On-Region Characteristics

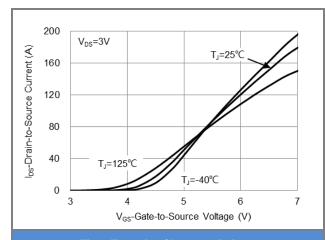


Fig.2 Transfer Characteristics

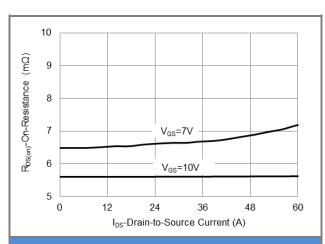


Fig.3 On-Resistance vs. Drain Current

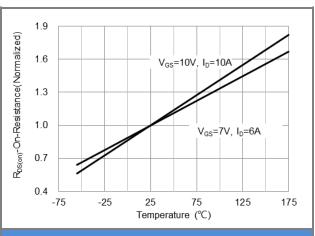
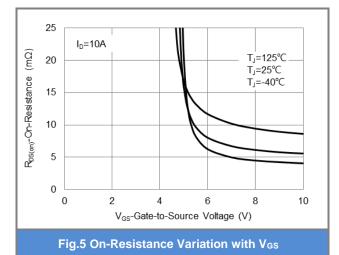
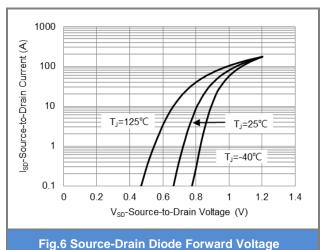


Fig.4 On-Resistance vs. Junction temperature





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TYPICAL CHARACTERISTIC CURVES

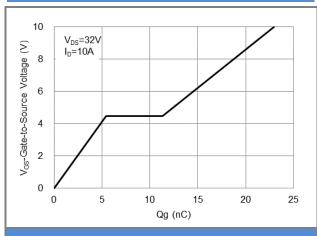


Fig.7 Gate-Charge Characteristics

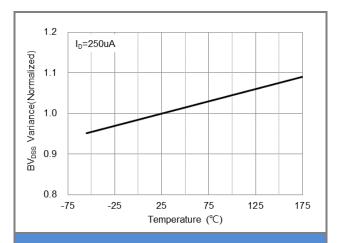


Fig.8 Breakdown Voltage Variation vs. Temperature

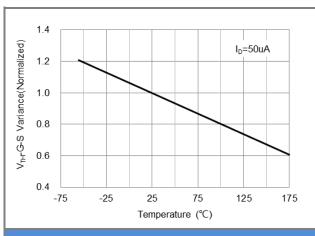


Fig.9 Threshold Voltage Variation with Temperature

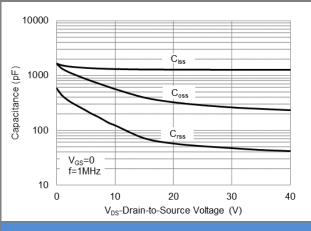
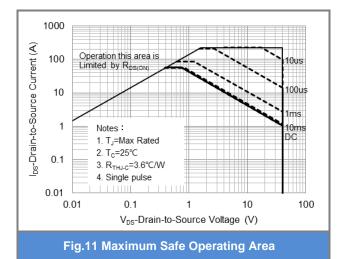
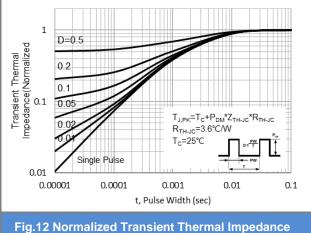


Fig.10 Capacitance vs. Drain-Source Voltage



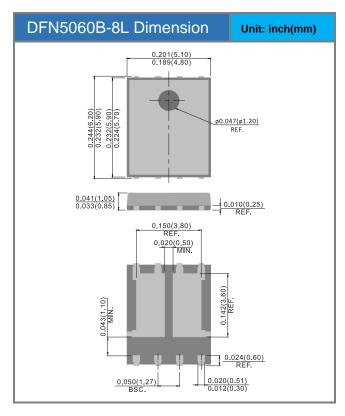


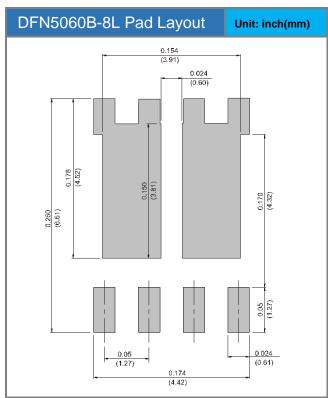


Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJQ5946V-AU	DFN5060B-8L	3K pcs / 13" reel	Q5946V

Packaging Information & Mounting Pad Layout







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